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J. Antu

REPLY UNDER 37 C.F.R. § 1.116
EXPEDITED PROCEDURE
EXAMINING GROUP 2829

PATENT
(5201-24300/01-120)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:
Hsiung, et al.

Serial No. 09/885,687

Filed: June 19, 2001

For: SEMICONDUCTOR DEVICE
PACKAGE SUBSTRATE PROBE
FIXTURE

§ Group Art Unit: 2829
§ Examiner: Nguyen, T.
§
§
§

Atty. Dkt. No. 5201-24300

I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as First Class Mail in an envelope addressed to: MS: AF, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313, on the date indicated below:

May 30, 2003
Date

Kevin L. Daffer

AMENDMENT AFTER FINAL REJECTION PURSUANT TO 37 C.F.R. § 1.116

MS: AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313

Dear Sir:

TECHNOLOGY CENTER 2800
JUN - 3 2003
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This paper is submitted in response to the Final Office Action mailed March 31, 2003. Amendments are made solely as to claim 1 by inserting into claim 1 the subject matter of claim 2. The combination of claims 1 and 2 was previously examined and, therefore, it is believed that this amendment does not warrant new matter or a renewed examination. Moreover, claim 20 is canceled in order to consolidate the issues for appeal. Thus, this amendment is believed to comply with placing the claims in better form for appeal under 37 C.F.R. § 1.116. Reconsideration is respectfully requested.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 6 of this paper.